



## THE U.S. PATENT AND TRADEMARK OFFICE

December 16, 2009

Applicants: Toshifumi KAWAMURA et al

Title: PRETREATING AGENT FOR ELECTROLESS PLATING,

METHOD OF ELECTROLESS PLATING USING THE SAME

AND PRODUCT OF ELECTROLESS PLATING

Serial No.: 10/586 379

Group: 1793

Confirmation No.: 2947

Filed: July 14, 2006

Examiner: Klemanski

International Application No.: PCT/JP2004/016764

International Filing Date: November 11, 2004

Atty. Docket No.: 4700.P0333US

Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

## Sir:

Herewith is an amendment in the above-identified application.

- [] Applicant claims small entity status. See 37 CFR 1.27.
- [] The additional filing fee has been calculated as shown below:

N	ю.	No.	(X)	RATE	()		
For Fi	.led	Extra	LG Entity		SM Entity	Fee	<b>=</b>
Total Claims (1	.2 -	20 = 0)	x \$ 52.00		x \$ 26.00		
Indep. Claims (	1 -	3 = 0)	x \$220.00		x \$110.00		
[ ] Multiple Dep. Claim			+ \$390.00		+ \$195.00		
* * * TOTAL FILING FEE * * *						\$	0.00

- [] Pursuant to 37 CFR 1.136(a), please extend the shortened period for response by month(s). The extension fee is: \$.
- [] A Check for \$ is enclosed to cover fees.
- [X] Please credit any overpayment, or charge any additional filing fee required under 37 CFR 1.16 or 1.17 by this communication, to Deposit Account No. 06-1382.

TFC/smd

Perryence F. Chapman Reg. No. 32 549

## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 16, 2009.

Terryence F. Chapman

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